

# The Chips Venture Forum





# The Chips Venture Forum



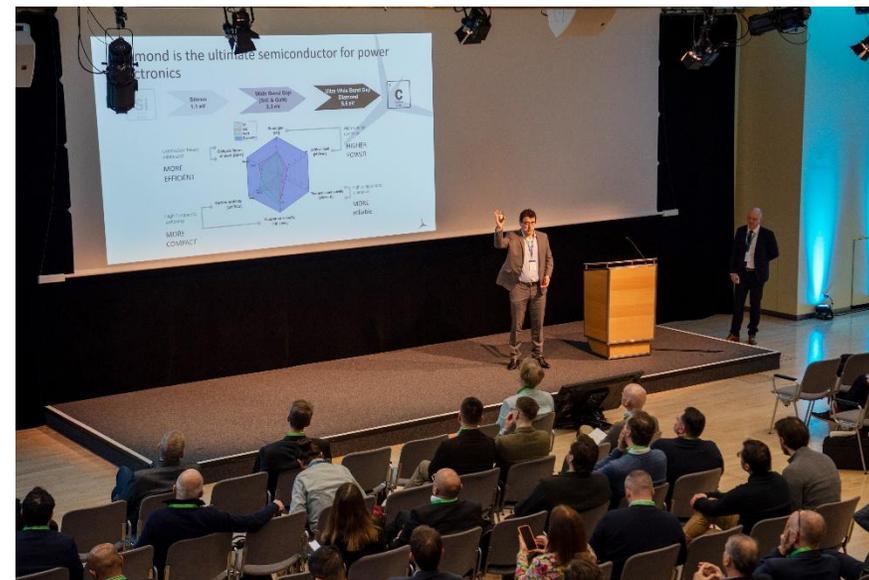
NETWORK OF COMPETENCE CENTERS, IN PARTNERSHIP WITH EIC –ACCELERATOR AND DG CONNECT



IN PRESENCE OF DEEP TECH VENTURE CAPITAL INVESTORS, CORPORATE VENTURES, CORPORATES



FIRST EDITION IN MÜNICH – SEMICON EUROPE 18TH OF NOVEMBER, 2025



A partnership between:



European Innovation Council



aCCcess has received funding from the European Union’s Digital Europe Chips JU under Grant Agreement No 101217840.





**150+**  
**participants**

**18 start-ups**  
**selected to pitch**



Funded by the  
European Union

aCCcess has received funding from the European Union under the Europe Chips JU under Grant Agreement



# 100+ One on One Meetings



Funded by the  
European Union

aCCcess has received funding from the European Union under the Marie Skłodowska Curie Europe Chips JU under Grant Agreement

Chips Venture Forum 2025  
Award Ceremony

# VERTICAL COMPUTE - Winner SPINNOCLOUD – Coup de coeur FARADAIC – Coup de coeur



# More than 50M€ raised or under negotiation

- 5 companies raised funds
- 5 companies have on-going discussions
- Deal sizes from early stage to series B
  - 2 deals > 10M€
  - 4 deals from 1 to 5M€
  - 4 deals > 1M€

# What they say about the CVF

*“The whole program was great”*

Sarah Luppino M Ventures

*The interest of the Chips Venture Forum for my organization lies in  
“Formation of ecosystem Building a pipeline for our investments”*

Hemut Gassel Silian Partners

*“It's great to have investors together, which have a real focus  
on deep tech. This makes discussions efficient and to the  
point.”*

Steve Stoffels Aluvia Photonics

*The interest of the Chips Venture Forum for my organization  
is to “screen new potentials of start-ups, develop a network  
focused on innovation and Europe sovereignty”*

Antoine Amade Entegris



# 70+ Confirmed Jury Members & Investors

- Cottonwood Technology Fund
- Lam Capital
- Photon Ventures
- TEL Venture Capital
- Ventech
- Santander
- LIFTT
- Mountain X
- Atlantic Bridge
- Obloo
- KBC Focus Fund
- Airbus
- IMEC xband
- Suss Microtec
- Partner, Matterwave Ventures
- Partner, DeepTech XL
- Indra Ventures
- Positron Ventures
- EE investments
- Evonik Venture Capital
- BGV
- Natural Ventures
- Signature Ventures
- SNGLR
- 360 Capital Partners
- Primo Capital
- ETF Partners
- Narwhale Ventures
- Medevice Capital
- Robert Bosch Venture Capital
- SETT
- Safran Corporate Ventures
- Hitachi High-Tech
- TRUMPF Venture
- Expansion Ventures
- Vigo Ventures
- Quantonation
- M Ventures
- First Imagine
- Entegris
- Riverside Investments
- ...

# Chips Venture Forum 2026



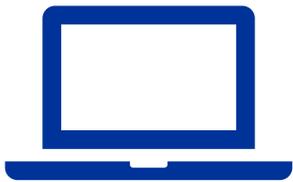
aCCcess in partnership with EIC & DG-CNCT

## 1<sup>st</sup> Eligibility requirement:

- Startup affiliated with a European Competence Center (CCC)
- Or EIC supported companies

# A competition in 2 phases: 2 face to face events

## Selection



Online



CVF at INPHO Venture  
Summit Bordeaux

## Final



Back to Back to Semicon  
Munich



# 1. Selection in Bordeaux : The Chips Venture Forum selection meeting will be embedded in the INPHO Venture Summit



# ABOUT INPHO



## “What’s next to invest in Deeptech”

Recognised biennial summit :

A Meeting Point for Deeptech Investors, including the Semiconductor Sector

**1 000**

**GUESTS**

hand-picked decision-makers  
interested in transformative  
technology investment

**150**

**SPEAKERS**

World-known and  
forward-thinking

**24**

**COUNTRIES**

from Europe, USA,  
Japan, and more.

**+1B€**

**CAPITAL RAISED**

# EDITORIAL COMMITTEE



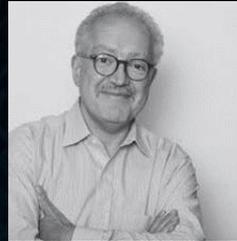
**GEORGE UGRAS**  
Chairman - Managing  
Director at AV8 Ventures



**HERVE FLOCH**  
General Manager at  
ALPHA-RLH



**GERALDINE ANDRIEUX**  
CEO at BLUMORPHO



**ERIC BENHAMOU**  
Founder at Benhamou  
Gloal Ventures



**FRANCOIS TISON**  
General Partner at 360  
Capital Partner



**AYMERIK RENARD**  
General Partner at HCVC



**MATHIEU COSTES**  
Partner at Airbus  
Ventures



**CHRISTIAN REITBERGER**  
Partner at Matterwave  
Ventures



**HIND BEAUJON**  
Chief Sales Officer at  
Pfeiffer Vacuum  
Technology



**NICOLAS LETERRIER**  
Semiconductor  
Sustainability Business  
Leader At Schneider  
Electric



**OLIVIER TONNEAU**  
Founder and Partner at  
Quantonation



**GIANLUCA DETTORI**  
Chairman, General  
Partner at Primo Capital



**CHRISTIAN CLAUSSEN**  
General Partner at  
Ventech



**GUUS FRERICKS**  
Founder & Managing  
Partner at DeepTechXL



**GIOVANNI BOLOGNA**  
Portfolio Manager at  
Santander Asset  
Management

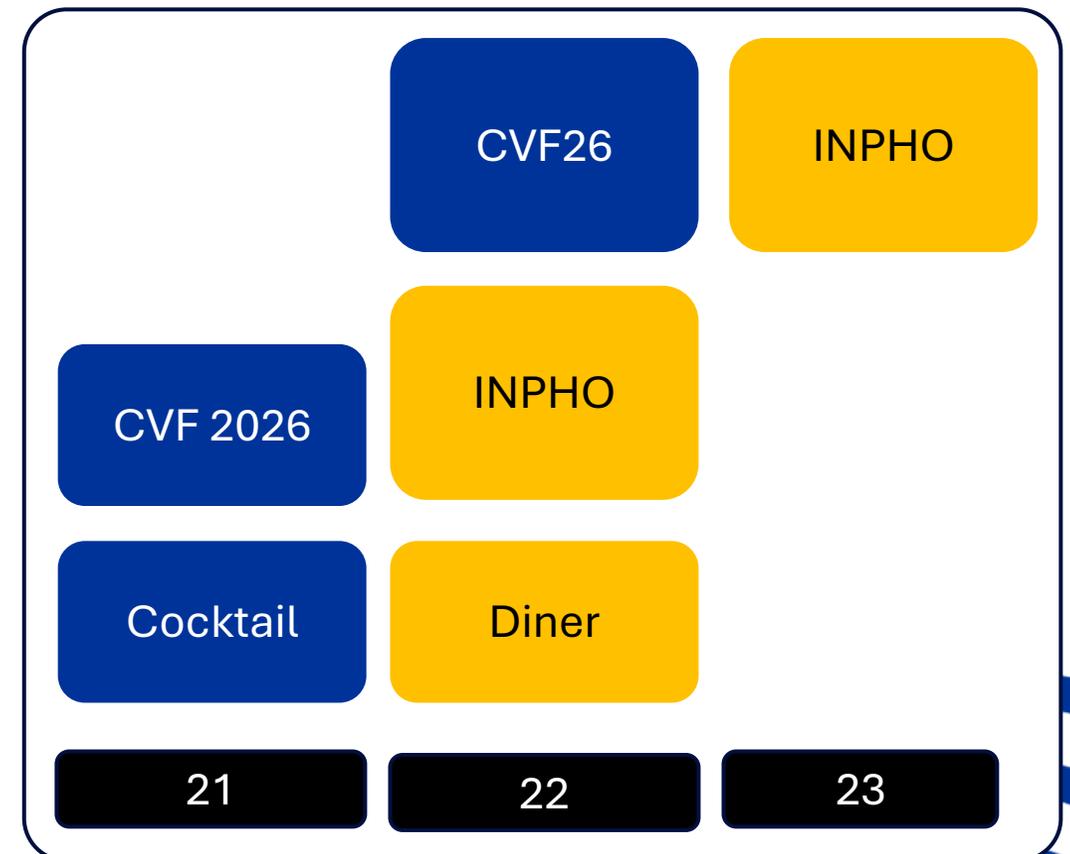


# The Chips Venture Forum: Selection

**21 & 22 october 2026**

# The Chips Venture Forum 2026 is leveraging INPHO Venture Summit.

- Access to the INPHO investor network: participants to the Chips Venture Forum **will have the full access to the INPHO Venture Summit**
- More time with investors
- Stronger engagement with semiconductor end-users
- Dedicated 1:1 meeting spaces
- Broader exposure to cross-cutting strategic topics





# Location : Palais de la Bourse



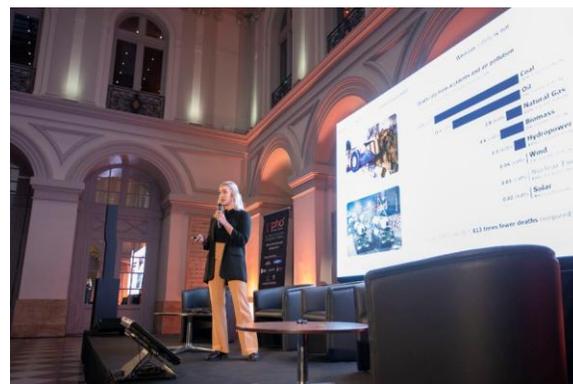
 Palais de la Bourse,  
17 place de la Bourse, Bordeaux



One on One



Networking



Pitching session



Insights



Funded by the  
European Union

aCCcess has received funding from the European Union's Digital Europe Chips JU under Grant Agreement No 101217840.



## 2. CVF26 Final in Semicon - Munich



# The Chips Venture Forum Final

**11-13 November 2026**



# Location : Messe Munchen



Nov 10–13, 2026 | MESSE MÜNCHEN | Co-located with electronica



aCCcess has received funding from the European Union's Digital Europe Chips JU under Grant Agreement No 101217840.



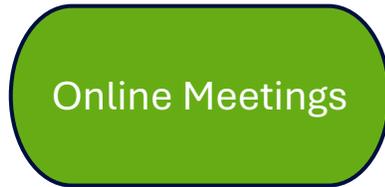
# The Process



17/03

12/05

CC are communicating about the Chips Venture Forum to their startups



03/06

12/06

Online Meetings

CC Stage Pitch Selection



Pitch Preparation



21/10- 22/10

inpho



**Chips Venture Forum Selection : Bordeaux**

- CC startups pitching sessions
- One to one meetings focused on fundraising

10/11- 13/11

Date TBD



**Chips Venture Forum Finale : Semicon - Munich**

- Semiconductor Startups pitching sessions
- Networking: investors, semiconductor corporates, and system integrators



# Selection criteria – CCC Startups

## Technology scope is unchanged

Startups must operate in at least one of the following domains:

- Mainstream Silicon Technologies,
- EDA & Design Automation,
- Packaging & Assembly,
- Test & Instrumentation Equipment,
- Materials & Substrates,
- Process Equipment & Manufacturing Tools,
- Power Electronics,
- MEMS & Sensors,
- RF & mmWave,
- AI/ML Hardware,
- Silicon Photonics,
- Quantum Technologies.



# Request the application link from your Competence Center



**aCCcess**

Find your CCC on:

<https://www.access.eu/>

Or send an email to:

[contact@access.eu](mailto:contact@access.eu)



Funded by the  
European Union

aCCcess has received funding from the European Union's Digital Europe Chips JU under Grant Agreement No 101217840.



SILICONALPS



VDI|VDE|IT

PROJECT PARTNERS